AUTOMOTIVE

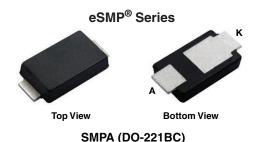
RoHS COMPLIANT

HALOGEN FREE



Vishay General Semiconductor

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



Anode Cathode

LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | | | | |
|--|-----------------|--|--|--|
| I _{F(AV)} | 8.0 A | | | |
| V_{RRM} | 45 V | | | |
| I _{FSM} | 120 A | | | |
| V_F at $I_F = 8.0 \text{ A } (T_A = 125 \text{ °C})$ | 0.40 V | | | |
| T _J max. | 150 °C | | | |
| Package | SMPA (DO-221BC) | | | |
| Circuit configuration | Single | | | |

FEATURES

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | |
|---|-----------------------------------|---|------|--|
| PARAMETER | SYMBOL | V8PAL45 | UNIT | |
| Device marking code | | 8L45 | | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 45 | V | |
| Maximum DC forward current | I _F ⁽¹⁾ | 8.0 | Α | |
| | I _F ⁽²⁾ | 4.0 | | |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I _{FSM} | 120 | А | |
| Operating junction and storage temperature range | T _J , T _{STG} | T _J , T _{STG} -40 to +150 | | |

Notes

- (1) Units mounted on 3 cm x 3 cm aluminum, 2 oz. PCB
- (2) Free air, mounted on recommended copper pad area



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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|------------------------|---|-------------------------------|------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | $I_F = 4.0 \text{ A}$ | I 26 °C | V _F ⁽¹⁾ | 0.43 | - | V |
| | $I_F = 8.0 \text{ A}$ | | | 0.49 | 0.57 | |
| | I _F = 4.0 A | T _A = 125 °C | | 0.32 | - | |
| | I _F = 8.0 A | | | 0.40 | 0.48 | |
| Reverse current | V _R = 45 V | $T_A = 25 ^{\circ}\text{C}$ $T_A = 125 ^{\circ}\text{C}$ | I _R ⁽²⁾ | - | 1850 | μΑ |
| | $V_R = 45 V$ T_A | T _A = 125 °C | | 11 | 30 | mA |
| Typical junction capacitance | 4.0 V, 1 MHz | | CJ | 1400 | - | pF |

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width $\leq 5 \text{ ms}$

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified) | | | | |
|---|---------------------------------|-----|------|--|
| PARAMETER SYMBOL V8PAL45 | | | | |
| Typical thermal resistance | R _{θJA} ⁽¹⁾ | 100 | °C/W | |
| | R _{θJM} ⁽²⁾ | 5 | | |

Notes

- $^{(1)}$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ junction to ambient
- (2) Units mounted on 3 cm x 3 cm aluminum, 2 oz. pad area; thermal resistance $R_{\theta JM}$ junction to mount

| ORDERING INFORMATION (Example) | | | | | |
|--------------------------------|--|---|---------------|------------------------------------|--|
| PREFERRED P/N | PREFERRED P/N UNIT WEIGHT (g) PREFERRED PACKAGE CODE | | BASE QUANTITY | DELIVERY MODE | |
| V8PAL45-M3/I | 0.032 | I | 14 000 | 13" diameter plastic tape and reel | |
| V8PAL45HM3_A/I (1) | 0.032 | 1 | 14 000 | 13" diameter plastic tape and reel | |

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise specified)

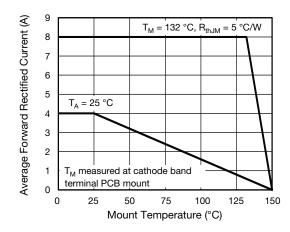


Fig. 1 - Maximum Forward Current Derating Curve

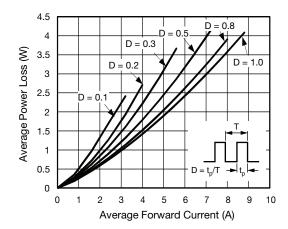


Fig. 2 - Forward Power Loss Characteristics



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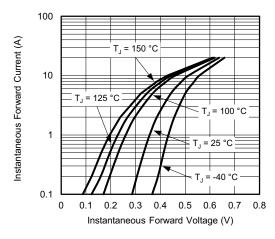


Fig. 3 - Typical Instantaneous Forward Characteristics

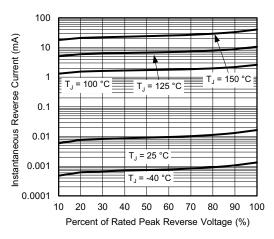


Fig. 4 - Typical Reverse Leakage Characteristics

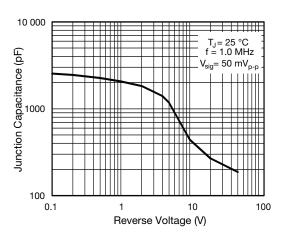


Fig. 5 - Typical Junction Capacitance

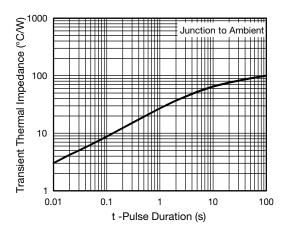


Fig. 6 - Typical Transient Thermal Impedance

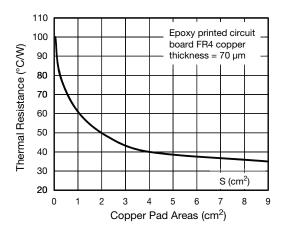


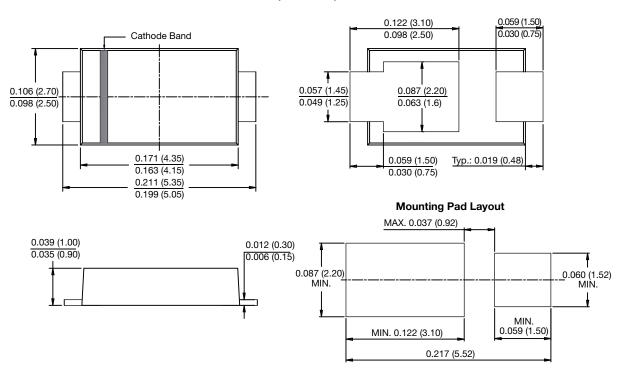
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMPA (DO-221BC)





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